## WHAT IS CLAIMED IS:

- 1 1. An electron beam lithography system, comprising:
- 2 an electron column for focusing said electron beam, and
- an electron gun, said electron gun comprising:
- 4 at least one laser; and
- 5 a photocathode substantially comprising cesium telluride and adapted
- 6 to be activated to generate electrons by said at least one laser and to be
- 7 regenerated by said at least one laser.
- 1 2. An electron beam lithography system in accordance with claim 1,
- 2 wherein said photocathode comprises a cesium telluride film on a substrate.
- 1 3. An electron beam lithography system in accordance with claim 2, said
- 2 photocathode including a metallic film interposed between said cesium telluride layer
- 3 and said substrate.
- 1 4. An electron beam lithography system in accordance with claim 2,
- 2 including means for applying a current in a plane of said cesium telluride layer.
- 1 5. A method for electron beam lithography, comprising:
- 2 applying at least one laser in a first mode to a cesium telluride photocathode
- 3 for generating electrons; and
- 4 applying said at least one laser to said cesium telluride photocathode in a
- 5 second mode to regenerate said cesium telluride photocathode.
- 1 6. A method according to claim 5, wherein in said first mode, said laser is
- 2 applied at a power density of approximately 10<sup>4</sup> Watts per square centimeter.
- 1 7. A method in accordance with claim 6, wherein in said second mode,
- 2 said at least one laser is applied at a power density in the range substantially
- 3 comprising  $10^4 10^6$  Watts per square centimeter.

- 1 8. A method in accordance with claim 6, wherein in said second mode,
- 2 said at least one laser is applied to raise a temperature of said cesium telluride
- 3 photocathode in the range substantially comprising 20 200 C above room
- 4 temperature.
- 1 9. A method in accordance with claim 8, a wavelength of said laser
- 2 comprising approximately 257 nanometers.
- 1 10. An electron gun, comprising:
- 2 at least one laser; and
- 3 a photocathode adapted to be activated to generate electrons by said at least
- 4 one laser and to be regenerated by said at least one laser
- 1 11. An electron gun in accordance with claim 10, wherein said
- 2 photocathode comprises a cesium telluride film on a substrate.
- 1 12. An electron gun in accordance with claim 11, said photocathode
- 2 including a metallic film interposed between said cesium telluride layer and said
- 3 substrate.
- 1 13. A method, comprising:
- 2 providing at least one laser; and
- 3 providing a photocathode adapted to be activated to generate electrons by
- 4 said at least one laser and to be regenerated by said at least one laser.
- 1 14. An method in accordance with claim 13, wherein said photocathode
- 2 comprises a cesium telluride film on a substrate.
- 1 15. An method in accordance with claim 14, said photocathode including a
- 2 metallic film interposed between said cesium telluride layer and said substrate..
- 1 16. An electron beam lithography system, comprising:

- 2 an electron column; and
- 3 an electron gun;
- 4 wherein said electron gun is adapted to apply at least one laser in a first
- 5 mode to a cesium telluride photocathode for generating electrons; and
- 6 said electron gun is adapted to apply said at least one laser to said cesium
- 7 telluride photocathode in a second mode to regenerate said cesium telluride
- 8 photocathode.
- 1 17. An electron beam lithography system according to claim 16, wherein in
- 2 said first mode, said at least one laser is applied at a power density of approximately
- 3 10<sup>4</sup> Watts per square centimeter.
- 1 18. An electron beam lithography system in accordance with claim 16,
- 2 wherein in said second mode, said at least one laser is applied at a power density in
- 3 the range substantially comprising  $10^4 10^6$  Watts per square centimeter.
- 1 19. An electron beam lithography system in accordance with claim 16,
- 2 wherein in said second mode, said at least one laser is applied to raise a
- 3 temperature of said cesium telluride photocathode in the range substantially
- 4 comprising 20 200 C above room temperature.
- 1 20. An electron beam lithography system in accordance with claim 19, a
- 2 wavelength of said laser comprising approximately 257 nanometers.
- 1 21. A controller for an electron beam lithography system, said controller
- 2 adapted to control application of at least one laser to a photocathode in a first mode
- 3 for generating electrons and in a second mode for regenerating said photocathode.
- 1 22. A controller in accordance with claim 21, said photocathode comprising
- 2 a cesium telluride photocathode.
- 1 23. A controller according to claim 21, wherein said controller is adapted to

- 2 control application of said at least one laser in said first mode, such that said at least
- 3 one laser is applied at a power density of approximately 10<sup>4</sup> Watts per square
- 4 centimeter.
- 1 24. A controller in accordance with claim 21, wherein said controller is
- 2 adapted to control application of said at least one laser in said second mode, such
- 3 that said at least one laser is applied at a power density in the range substantially
- 4 comprising  $10^4 10^6$  Watts per square centimeter.
- 1 25. A controller in accordance with claim 21, wherein said controller is
- 2 adapted to control application of said at least one laser in said second mode, such
- 3 that said at least one laser is applied to raise a temperature of said cesium telluride
- 4 photocathode in the range substantially comprising 20 200 C above room
- 5 temperature,